TVL 0402 01 AB1 Engineering Specification

1 Scope

TVL 0402 01 AB1 is a TVS diode designed to protect one power/control line or one low speed signal line from overvoltage hazard of Electrostatic Discharge (**ESD**).

These interfaces can be used in computer interfaces protection, microprocessors protection, serial and parallel ports protection, control signal lines protection, power lines on PCB protection, latchup protection, etc. The ESD protection of TVS meets the immunity standard of IEC 61000-4-2, level 4 (±15kV air, ±8kV contact discharge).

2 Explanation of Part Number

TV L 0402 01 AB1 (1) (2) (3) (4) (5)

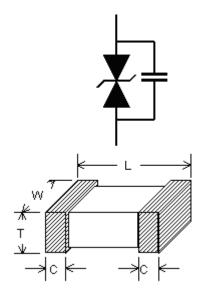
(1) Product Type: TV=TVS Diode

(2) Capacitance Code: L=Low Capacitance

(3) Package Size Code

(4) Channel Code : 01=1 Channels(5) Specialized Specification Code

3 . Circuit Diagram & Dimension



Unit: mm	0402
L	1.10±0.1
W	0.50±0.10
Т	0.50±0.10
С	0.25±0.15

UNLESS OTHER SPECIFIED	TOLERANCES ON :				
$X=\pm$ $X.X=\pm$ $X.XX=\pm$		G	INPAQ TECHNOLOGY CO., LTD.		
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TITLE: TVL 0402 01 AB1		DOCUMENT	ENC000024470	SPEC REV.	
Engineering Specification		NO.	ENS000024170	A1	

4 Specifications

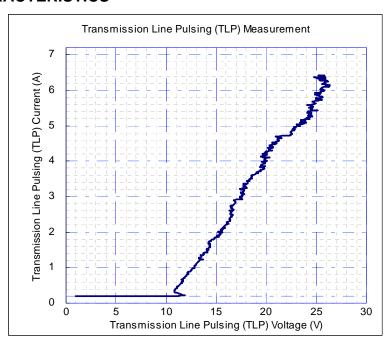
4.1 ABSOLUTE MAXIMUM RATINGS

PARAMETER	PARAMETER	RATING	UNITS
Operating Supply Voltage	V_{DC}	5.5	V
ESD per IEC 61000-4-2 (Air)	V_{ESD}	±15	kV
ESD per IEC 61000-4-2 (Contact)		<u>±</u> 8	
Lead Soldering Temperature	T _{SOL}	260 (10 sec.)	$^{\circ}$ C

4.2 ELECTRICAL CHARACTERISTICS

	ELECTRICAL CHARACTERISTICS						
PARAMETER	SYMBOL	CONDITIONS	MINI	TYP	MAX	UNI TS	
Reverse Stand-Off Voltage	V_{RWM}	T=25 °C.			6	V	
Reverse Leakage Current	l _{Leak}	V _{RVM} = 5V, T=25 °C.			1	μА	
Reverse Breakdown Voltage	V_{BV}	I _{BV} = 1mA, T=25 °C.		10		V	
Clamping Voltage	V_{CL}	I _{PP} =1A, tp=8/20us, T=25 °C.		14	15	V	
Channel Input Capacitance	C _{IN}	V _R = 0V, f = 1MHz, T=25 °C.		6		pF	

4.3TYPICAL CHARACTERISTICS



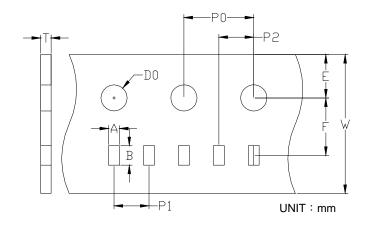
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5. Taping Package and Label Marking

5.1 Packaging method

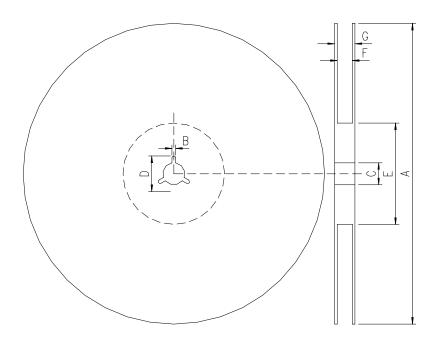
Products shall be heat-sealed in the chip pocket, spacing pitch 4-mm of plastic carrier tape with cover tape, and the carrier tape shall be reeled to the reel.

5.2 Carrier tape dimensions



Туре	Α	В	W	Е	F	P0	P1	P2	D0	Т
0402	0.58	1.3	8.0	1.75	3.5	4.0	2.0	2.0	1.55	0.60
	±0.03	±0.03	±0.1	±0.05	±0.05	±0.1	±0.05	±0.05	±0.05	±0.03

5.3 Taping reel dimensions



Α	178.0±2.0
В	2.0±0.5
С	13.0±0.5
D	21.0±0.8
Ε	62.0±1.5
F	9.0±0.5
G	13.0±1.0

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5.4 Taping specifications

There shall be the portion having no product in both the head and the end of taping, and there shall be the cover tape in the head of taping.

5.5 Label Marking

The label specified as follows shall be put on the side of reel.

- (1) Part No.
- (2) Quantity
- (3) Lot No.

5.6 Quantity of products in the taping package

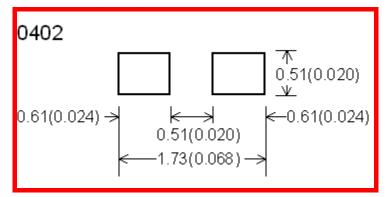
- (1) Standard quantity: 10,000pcs/Reel for TVL0402 Series
- (2) Shipping quantity is a multiple of standard quantity.

6. Precautions for Handling

6.1 Solder cream in reflow soldering

Refer to the recommendable land pattern as printing mask pattern for solder cream.

- (1) Print solder in a thickness of 150 to 200 μ m.
- (2) Dimensions: millimeters (inches)



6.2 Precaution for handling of substrate

Do not exceed to bend the board after soldering this product extremely. (Reference examples)

- Mounting place must be as far as possible from the position, which is close to the break line of board, or on the line of large holes of board.
- Do not bend extremely the board, in mounting another components.
 If necessary, use back-up pin (support pin) to prevent from bending extremely.
- Do not break the board by hand. We recommend using the machine or the jig to break it.

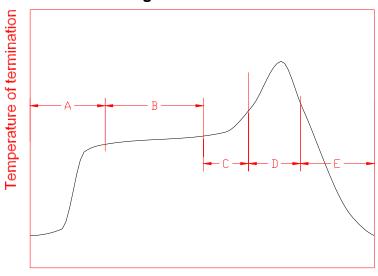
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^{*}Part No. And Quantity shall be marked on outer packaging.

6.3 Precaution for soldering

Note that rapid heating, rapid cooling or local heating will easily damage this product. Do not give heat shock over 100°C in the process of soldering. We recommend taking preheating and gradual cooling.

6.4 Recommendable reflow soldering



Time

Α	1 st rising temperature	The normal to Preheating	30s to 60s
		temperature	
В	Preheating	140°C to 160°C	60s to 120s
С	2 nd rising temperature	Preheating to 200°C	20s to 40s
D	Main heating	if 220℃	50s∼60s
		if 230℃	40s∼50s
		if 240℃	30s∼40s
		if 250℃	20s∼40s
		if 260℃	20s∼40s
Е	Regular cooling	200°C to 100°C	1°C/s ~ 4°C/s

^{*}According to J-STD-020C

6.5 Soldering gun procedure

Note the follows, in case of using solder gun for replacement.

- (1) The tip temperature must be less than 280°C for the period within 3 seconds by using soldering gun less than 30 W.
- (2) The soldering gun tip shall not touch this product directly.

6.6 Soldering volume

Note that excess of soldering volume will easily get crack the body of this product.

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